

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q84452

Michel PUECH, et al.

Appln. No.: 10/516,455

Group Art Unit: 1763

Confirmation No.: 2876

Examiner: Allan W. OLSEN

Filed: December 3, 2004

For: METHOD AND DEVICE FOR SUBSTRATE ETCHING WITH VERY HIGH POWER
INDUCTIVELY COUPLED PLASMA

PETITION FOR EXTENSION OF TIME UNDER 37 C.F.R. § 1.136

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. § 1.136, Applicant hereby petitions for an extension of time of two months, extending the time for responding to the Office Action of December 18, 2006 to May 18, 2007.

A check for the statutory fee of \$450.00 is attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this sheet is enclosed.

Respectfully submitted,



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for Dion R. Ferguson
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WASHINGTON OFFICE

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CUSTOMER NUMBER

Date: May 18, 2007